Attorney's Docket No.: 07977-218003 / US3S31/3615D1D1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Shunpei Yamazaki et al. Art Unit : 3663

Serial No.: 10/753,524 Examiner: Johannes P. Mondt

Filed : January 9, 2004 Conf. No.: 7877

Title : SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE

SAME

MAIL STOP AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Applicants request consideration of the references listed on the attached PTO-1449 form. Under 37 C.F.R. § 1.98 (a)(2)(ii), only copies of foreign patent documents and/or non-patent literature are enclosed. Copies of any listed U.S. patents or U.S. patent application publications can be provided upon request.

Submitted herewith is an English translation of the following foreign language references, or portions thereof:

Desig. ID	Source
AL	JAPAN 09-162416 - English abstract provided by esp@cenet Worldwide (2007) and family to U.S. Patent No. 5,922,125 (Desig. ID "AC"), U.S. Patent No. 6,225,645 (Desig. ID "AF") and U.S. Patent Application Publication No. 2001/0022364 A1 (Desig. ID "AA")
AM	JAPAN 10-209465 - English abstract provided by esp@cenet Worldwide (2007) and family to U.S. Patent No. 6,730,932 (Desig. ID "AI"), U.S. Patent No. 6,380,560 (previously cited in Information Disclosure Statement filed on January 9, 2004), and U.S. Patent Application Publication No. 2004/0164300 A1 (Desig. ID "AB")
AN	JAPAN 10-223530 - English abstract provided by esp(acenet Worldwide (2007)
AO	JAPAN 10-247735 - English abstract provided by esp@cenet Worldwide (2007) and family to U.S. Patent No. 6,165,824 (Desig. ID "AE") and U.S. Patent No. 6,479,333 (Desig. ID "AO")
AP	JAPAN 10-301146 - English abstract provided by esp@cenet Worldwide (2007) and family to U.S. Patent No. 6,133,075 (Desig. ID "AD"), U.S. Patent No. 6,524,896 (Desig. ID "AH") and U.S. Patent No. 6,864,127 (Desig. ID "AJ")
AQ	JAPAN 10-301147 - English abstract provided by esp@cenet Worldwide (2007) and family to U.S. Patent No. 6,133,075 (Desig. ID "AD"), U.S. Patent No. 6,524,896 (Desig. ID "AH") and U.S. Patent No. 6,864,127 (Desig. ID "AJ")

This statement is being filed after a first Office action on the merits, but before receipt of a final Office action or a Notice of Allowance. Applicants hereby certify that each item of information contained in this statement, with the exception of references "AA" to "AJ", (i) was cited in a communication from a foreign patent office in a counterpart foreign application, the

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Serial No. : 10/753,524 Filed January 9, 2004

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communication being dated April 3, 2007, which is not more than three months prior to the filing of this statement, and (ii) was not first cited in any communication from a foreign patent office in a counterpart application which was more than three months prior to the filing date of this statement. References "AA" to "AJ" are English-language documents corresponding to references "AL" to "AQ" as set forth above, and are cited in accordance with MPEP 609(III)(B)(5).

No fees are believed due. Please apply any charges or credits to Deposit Account No. 06-1050.

Respectfully submitted,

Attorney's Docket No.: 07977-218003 / US3531/3615D1D1

Date: July 2, 2007

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Substitute Form PTO-1449 (Modified)

U.S. Department of Commerce Patent and Trademark Office Attorney's Docket No. 07977-218003

Application No. 10/753,524

information Disclosure Statement by Applicant (Use several sheets if necessary) Applicant Shunnei Yamayaki

January 9, 2004

Filing Date

Shunpei Yamazaki et al.

Group Art Unit 3663

(37 CFR §1.98(b))

U.S. Patent Documents Filing Date Examiner Desig. Document Publication Date Patentee Class Subclass If Appropriate ID Number Initial 03/12/2001 2001/0022364 A1 09/20/2001 AA Zhang Yamazaki et al. 01/09/2004 AB 2004/0164300 A1 08/26/2004 12/10/1996 AC 5,922,125 07/13/1999 Zhang 10/17/2000 Yamazaki et al. 04/24/1998 6,133,075 AD Takano et al. 03/03/1998 6,165,824 12/26/2000 AE 05/03/1999 AF 6,225,645 B1 05/01/2001 Zhang Takano et al. 03/21/2000 6,479,333 B1 11/12/2002 AG Yamazaki et al. 07/14/2000 02/25/2003 AH 6,524,896 B1 05/04/2004 Yamazaki et al. 03/26/2002 AI 6,730,932 B2 03/08/2005 Yamazaki et al. 02/04/2003 Ai 6.864,127 B2 AX

Examiner	Foreign Patent Documents or Pu Examiner Desig. Document Publication		Country or			Translation		
Initial	שו	Number	Date	Patent Office	Class	Subclass	Yes	No
	AL	09-162416	06/20/1997	JAPAN			AB	
	AM	10-209465	08/07/1998	JAPAN°			AB	
	AN	10-223530	08/21/1998	JAPAN		,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	AB	
	AO	10-247735	09/14/1998	JAPAN			AB	
	AP	10-301146	11/13/1998	JAPAN			AB	
	AQ	10-301147	11/13/1998	JAPAN			AB	

	Other Do	ocuments (include Author, Title, Date, and Place of Publication)
Examiner Initial	Desig. ID	Document
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1	Examiner Signature	Date Considered				
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Γ	EXAMINER: Initials citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with					
	next communication to applicant.					